

# ECTC 2011

The 61st Electronic Components and Technology Conference

## Thank you for attending the 61st ECTC

I would like to thank all the authors, presenters, program committee members, exhibitors, sponsors and all attendees for making the 61st ECTC such a rousing success.

Here are some conference statistics:

- Over 1,000 attendees from 32 countries
- 342 technical papers presented in 36 oral and five poster sessions including a student poster session
- Over 60 papers/posters presented on 3D/TSV
- 16 professional development courses attended by a record 386 participants
- 61 Technical Corner exhibitors

In addition to the regular daytime sessions and courses, we offered three night seminars which were very well attended and a special manufacturing session.

- **ECTC Panel Discussion**  
*Chaired by CPMT President Rolf Aschenbrenner, Germany*  
Discussed China's growth and impact on the semiconductor industry.
- **ECTC Plenary Session**  
*Chaired by Henning Braunsch, Intel Corporation, United States*  
Focused on power efficiency challenges ranging from space exploration and supercomputers to challenges in data centers, consumer electronics and medical implants.
- **CPMT Seminar**  
*Chaired by Kishio Yokouchi, Fujitsu Interconnect Technologies Ltd., Japan*  
Discussed the latest in the emerging fields of printed devices and large area interconnect technologies for flexible electronics.
- **Special session**  
*Chaired by Lei Shan, IBM Corporation, United States*  
Discussed the impact of manufacturing limitations on electronic package performance and reliability.

Finally, the ECTC luncheon speaker, Nasser Grayeli from Intel Corporation, provided excellent insights into meeting the challenges faced with the steep growth of smart devices, the interdependence of all of us in the supply chain and the need to develop robust quality systems that focus on prevention rather than containment. Nasser was able to captivate more than 700 luncheon attendees.

I would like to thank our corporate sponsors - in particular the Gala sponsors: Global Foundries, Powertech Technologies, Amkor Technologies, ASE Group, Applied Materials, Microsoft, and Murata - and all who participated in the 61st ECTC.

Photos taken at the conference are posted on [Flickr](#).

**Next year's conference will be held May 29 – June 1, 2012 at the Sheraton San Diego Hotel and Marina, San Diego, California.**

I hope to see you there,



Rajen Dias  
General Chair, 61th Electronic Components and Technology Conference  
Intel Corporation

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